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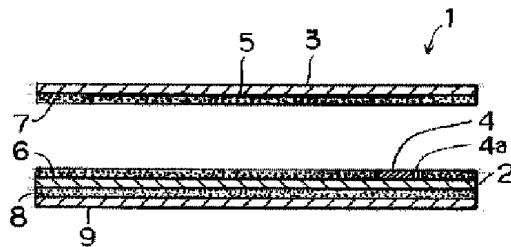
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(54) NON-CONTACT IC LABEL

(57) Abstract:

PROBLEM TO BE SOLVED: To provide a non-contact IC label whose use range can be extended and which can be used by only exchanging a damaged IC chip piece or antenna piece.

SOLUTION: This non-contact IC label 1 consists of an IC chip piece 2 provided an IC chip 4 on one surface side and an antenna piece 3 provided with an antenna 5 on one surface side, an IC chip installation surface and an antenna installation surface of the respective pieces 2 and 3 are provided with adhesive structures 6 and 7 for integrating the respective pieces 2 and 3 in a separable way, and when the respective card parts 2 and 3 are integrated, the IC chip 4 and the antenna 5 are connected to carry out a function as a non-contact IC label.



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